ASBOCIATION CONNECTING LECTROMICS INDUSTRIES®	C. Bannockb	ourn. Illinois. A	ll rights reserved untions.	under both	This docume level parts, t	ent is a declaration en declaration	on of the su	bstances w all lower	vithin the manufactu level materials for v	rer listed which the	item. Note: manufacture	if the item is an as r has engineering	sembly with low responsibility.	
				Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information					tion				
Supplier Information														
Company name* Comp			ompany unique ID			Unique ID Authority				Respon	Response Date*			
onsemi										2023-06-08				
Contact Name	tact Name Title - Contact					Phone - Contact*				Email ·	Email - Contact*			
Product-Env-Stewards Product Enviro			viro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Repres			esentative			Phone - Representative*			Email - Representative*					
Product-Env-Stewards Produ			Product Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Item Number		Mfr Item Name			Effective Date	fective Date Version Manufacturing Site		anufacturing Site		Weight*	UOM	Unit Type	
	FAN533	V5331SX DC/DC Boost LED		ED Driver		2023-06-08		PI	РВВ		17.013	mg	Each	
Aanufacturing Proccess Information	on													
Terminal Plating / Grid Array Mate	erial T	Terminal Base Alloy J-S		J-STD-020 MSI	Rating	Peak Process Body Temperat		mperature	ure Max Time at Peak Temper		ture Num	ber of Reflow Cyc	les	
Matte Tin (Sn) - annealed CU Alloy		CU Alloy		1		260		С	30	seco	nds 3			
omments														
vel 1 - maximum time at peak temperature	e during sol	dering is 10-3	0 seconds											
or more information regarding material co	mposition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl obthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select select a RoHS exemption, if applic sigma range of distribution unless	cable [E] enter the weigh	Requester or Supplier) [B t of the substance or the Pl] select the substa PM concentration	ance category (JIG or Requester) or enter a [F] Optionally enter the positive (+) and n	value (Supplier). [C] se egative (-) tolerance in p	lect the substance (Jl percent (Note: percer	G) or enter the substant tolerance values are	nce and CAS (Other). [D] expected to cover a 3
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.745	mg	Supplier	Silicon (Si)	7440-21-3		0.745	mg
Die Attach	0.052	mg	Supplier	Silver (Ag)	7440-22-4		0.0439	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.0081	mg
Lead Frame	7.29	mg	Supplier	Silver (Ag)	7440-22-4		0.008	mg
			Supplier	Copper (Cu)	7440-50-8		7.282	mg
Mold Compound-Black	8.4	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		1.68	mg
			Supplier	Carbon Black (C)	1333-86-4		0.084	mg
			Supplier	Silica (SiO2)	14464-46-1		6.636	mg
Plating	0.453	mg	Supplier	Tin (Sn)	7440-31-5		0.453	mg
Wire Bond - Au	0.073	mg	Supplier	Gold (Au)	7440-57-5		0.073	mg